SUBMINIATURE SOLID STATE LAMP



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

AM2520MBCK03

BLUE

Features

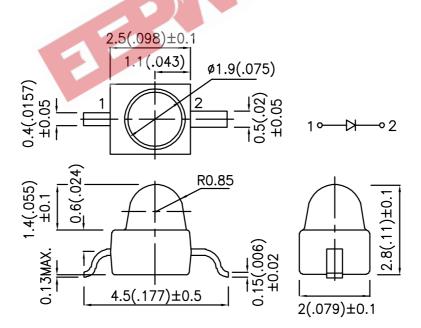
- •SUBMINIA TURE PACKAGE.
- •WIDE VIEWING ANGLE.
- •GULL WING LEAD.
- •LONG LIFE SOLID STATE RELIABILITY.
- •LOW PACKAGE PROFILE.
- •PACKAGE: 1000PCS/REEL.
- •RoHS COMPLIANT.

Description

The Blue source color devices are made with GaN on SiC Light Emitting Diode.

Static electricity and surge damage the LEDS. It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs. All devices, equipment and machinery must be electrically grounded.

Package Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25(0.01") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.

 SPEC NO: DSAD1262
 REV NO: V.3
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 APPROVED: J. Lu
 CHECKED: Allen Liu
 DRAWN: B.H.Ll
 ERP: 1202000525

Selection Guide

Part No.	Dice	Lens Type	lv (m @ 20	,	Viewing Angle
		,,	Min.	Тур.	201/2
AM2520MBCK03	BLUE (GaN)	WATER CLEAR	10	30	20°

Note:

Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Blue	430		nm	IF=20mA
λD	Dominant Wavelength	Blue	466	. 4	nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Blue	60	30	nm	IF=20mA
С	Capacitance	Blue	100	-0.5	pF	VF=0V;f=1MHz
VF	Forward Voltage	Blue	4.0	5.2	V	IF=20mA
lR	Reverse Current	Blue	.0	10	uA	VR = 5V

Absolute Maximum Ratings at Ta=25°C

Parameter	Blue	Units	
Power dissipation	105	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating/Storage Temperature	-40°C To +85°C		

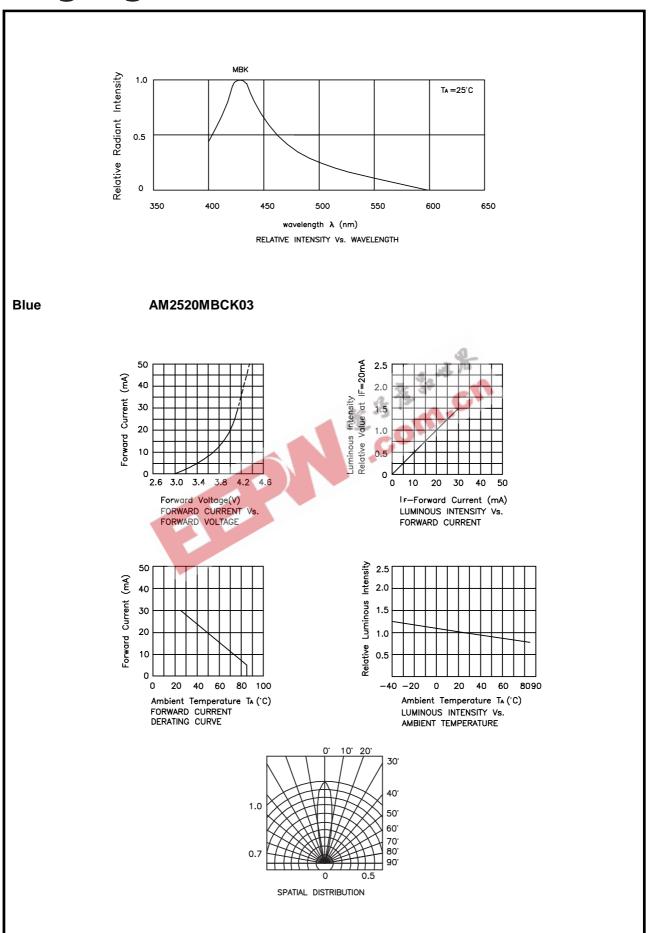
Note

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^{1.} θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

^{1. 1/10} Duty Cycle, 0.1ms Pulse Width.

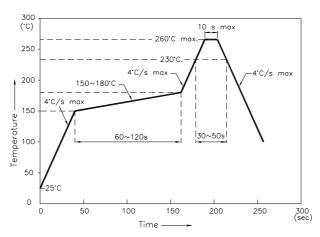


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AM2520MBCK03

Reflow Soldering Profile For Lead-free SMT Process.



NOTES:

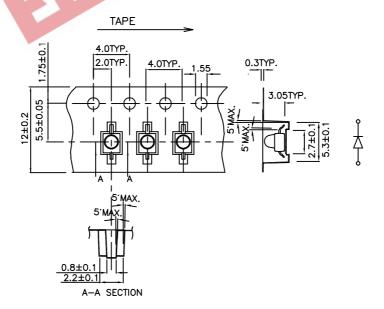
- 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it $\,$ is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern

(Units: mm)



Tape Specifications (Units: mm)



Remarks

- If there is sorting requirement (eg. forward voltage, luminous intensity or wavelength), the condition as follows:
- 1. Wavelength: +/-1nm (Test condition is based on the sorting standard).
- 2.Luminous intensity: +/-15% (Test condition is based on the sorting standard).
- 3. Forward voltage: +/-0.1V (Test condition is based on the sorting standard).

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